TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# **TC74HC4072AP, TC74HC4072AF**

#### **Dual 4-Input OR Gate**

The TC74HC4072A is a high speed CMOS 4-INPUT OR GATE fabricated with silicon gate  $C^2$ MOS technology.

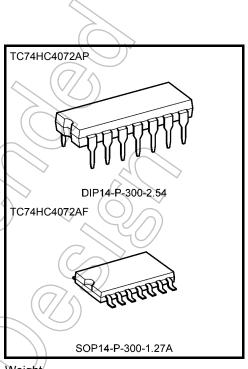
It achieves the high speed operation similar to equivalent LSTTL while maintaining the CMOS low power dissipation.

The internal circuit is composed of 4 stages including buffered outputs, which provide high noise immunity and stable output.

All inputs are equipped with protection circuits against static discharge or transient excess voltage.

#### **Features**

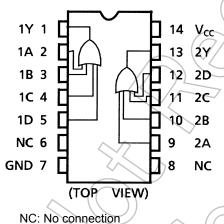
- High speed:  $t_{pd} = 9$  ns (typ.) at  $V_{CC} = 5$  V
- Low power dissipation:  $I_{CC} = 1 \mu A \text{ (max)}$  at  $T_{a} = 25 \text{°C}$
- High noise immunity: V<sub>NIH</sub> = V<sub>NIL</sub> = 28% V<sub>CC</sub> (min)
- Output drive capability: 10 LSTTL loads
- Symmetrical output impedance: | I<sub>OH</sub> | = I<sub>OL</sub> = 4 mA (min)
- Balanced propagation delays:  $t_{pLH} \approx t_{pHL}$
- Wide operating voltage range: VCC (opr) = 2 to 6 V
- Pin and function compatible with 4072B



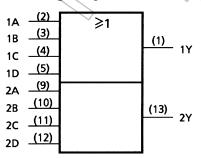
Weight

DIR14-P-300-2.54 : 0.96 g (typ.) SOP14-P-300-1.27A : 0.18 g (typ.)

### Pin Assignment



### **IEC Logic Symbol**



Start of commercial production 1988-05

#### **Truth Table**

Α	В	С	D	Υ
Н	Х	Х	Х	Н
Х	Н	Х	Х	Н
Х	Х	Н	Х	Н
Х	Х	Х	Н	Н
L	L	L	L	L

X: Don't care

### **Absolute Maximum Ratings (Note 1)**

Characteristics	Symbol	Rating	Unit
Supply voltage range	V <sub>CC</sub>	-0.5 to 7	V
DC input voltage	V <sub>IN</sub>	-0.5 to V <sub>CC</sub> + 0.5	V
DC output voltage	V <sub>OUT</sub>	-0.5 to V <sub>CC</sub> + 0.5	V
Input diode current	I <sub>IK</sub>	±20	mA
Output diode current	lok	±20	mA
DC output current	lout	±25	_mA
DC V <sub>CC</sub> /ground current	Icc	±50	∫ mA
Power dissipation	P <sub>D</sub>	500 (DIP) (Note 2)/180 (SOP)	mW
Storage temperature	T <sub>stg</sub>	-65 to 150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta = -40 to 65°C. From Ta = 65 to 85°C a derating factor of -10 mW/°C shall be applied until 300 mW.

## **Operating Ranges (Note)**

Characteristics	Symbol	Rating	Unit
Supply voltage	Vcc	2 to 6	V
Input voltage	V <sub>IN</sub>	0 to V <sub>CC</sub>	V
Output voltage	Vout	0 to V <sub>CC</sub>	V
Operating temperature	T <sub>opr</sub>	−40 to 85	°C
		0 to 1000 (V <sub>CC</sub> = 2.0 V)	
Input rise and fall time	t <sub>r</sub> , t <sub>f</sub>	0 to 500 (V <sub>CC</sub> = 4.5 V)	ns
		0 to 400 (V <sub>CC</sub> = 6.0 V)	

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either V<sub>CC</sub> or GND.



#### **Electrical Characteristics**

#### **DC Characteristics**

Characteristics	Symbol	Test Condition			Ta = 25°C		Ta = -40 to 85°C		Unit	
	J25.			V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	J
		_		2.0	1.50	_ <	/_	1.50	_	
High-level input voltage	V <sub>IH</sub>			4.5	3.15	_		3.15	_	V
				6.0	4.20		( <del>\</del>	4.20	_	
						40	0.50	_	0.50	
Low-level input voltage	V <sub>IL</sub>	_		4.5	4	/ <del>/</del> //	1)35	_	1.35	V
				6.0	-2		1.80	_	1.80	
		V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>		2.0	1.9	2.0	<sup>&gt;</sup> —	1.9	_	
			$I_{OH} = -20 \mu A$	4.5	4.4	4.5	_	4.4	_	
High-level output voltage	V <sub>OH</sub>			6.0	5.9	6.0	_	5.9	$\rightarrow$	V
			$I_{OH} = -4 \text{ mA}$	4.5	4.18	4.31	{	4.13	> -	
			$I_{OH} = -5.2 \text{ mA}$	6.0	5.68	5.80	-(	5.63	_	
		V <sub>IN</sub> = V <sub>IL</sub>	(	2.0		0.0	0.1	4	0.1	
			I <sub>OL</sub> = 20 μA	4.5	_	0.0	⊋0.1	>	0.1	
Low-level output voltage	V <sub>OL</sub>		4	6.0	_	0.0	(0.1)	_	0.1	V
-			I <sub>OL</sub> = 4 mA	4.5	_	0.17	0.26	_	0.33	
			I <sub>OL</sub> = 5.2 mA	6.0	_	0.18	0.26	_	0.33	
Input leakage current	I <sub>IN</sub>	$V_{IN} = V_{CC}$ or	GND	6.0			±0.1	_	±1.0	μА
Quiescent supply current	Icc	$V_{IN} = V_{CC}$ or	GND	6.0		/	1.0	_	10.0	μА

# AC Characteristics ( $C_L = 15 \text{ pF}$ , $V_{CC} = 5 \text{ V}$ , $Ta = 25^{\circ}\text{C}$ , input: $t_r = t_f = 6 \text{ ns}$ )

Characteristics	Sýmbol	Test Condition	Min	Тур.	Max	Unit
Output transition time	t <sub>TLH</sub>	<u> </u>	-	4	8	ns
Propagation delay time	t <sub>pLH</sub>	_		9	16	ns



# AC Characteristics (C $_{L}=50\ pF,$ input: $t_{r}=t_{f}=6\ ns)$

Characteristics	Symbol Test Condition			Ta = 25°C			Ta = -40 to 85°C		Unit
	,		V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	
	4		2.0	_	30	75	_	95	
Output transition time	t <sub>TLH</sub>	_	4.5	_	8	15	_	19	ns
	t <sub>THL</sub>		6.0	_	7	13	_	16	
	4		2.0	_	36	100	12	125	
Propagation delay time	t <sub>pLH</sub> —	_	4.5	_	12	20	<i>y</i> _	25	ns
	t <sub>pHL</sub>		6.0	_	10	/17	_	21	
Input capacitance	C <sub>IN</sub>	_		-	5	10	_	10	pF
Power dissipation capacitance	C <sub>PD</sub> (Note)	_		-(	22)	> —	_	_	pF

Note: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

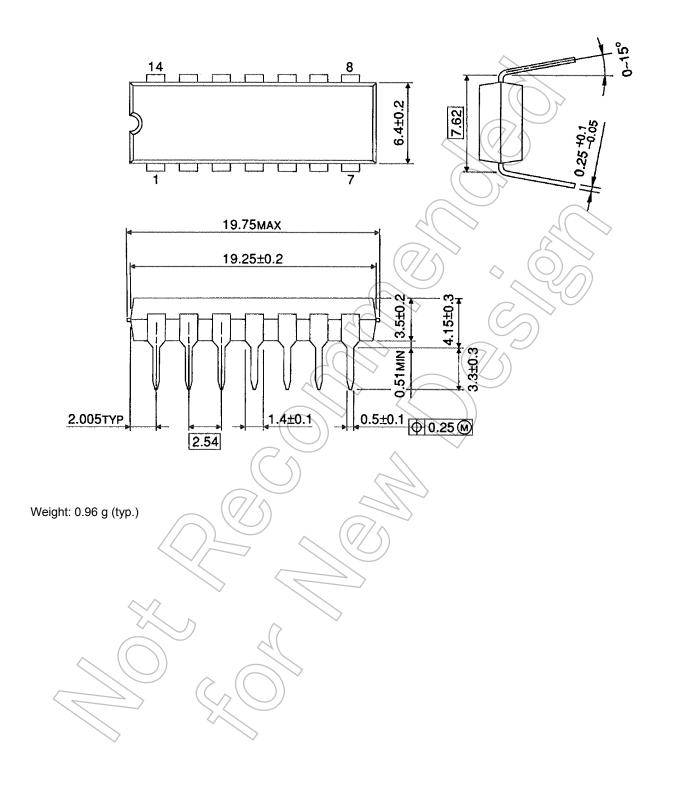
Average operating current can be obtained by the equation:

 $I_{CC}$  (opr) =  $C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/2$  (per gate)



### **Package Dimensions**

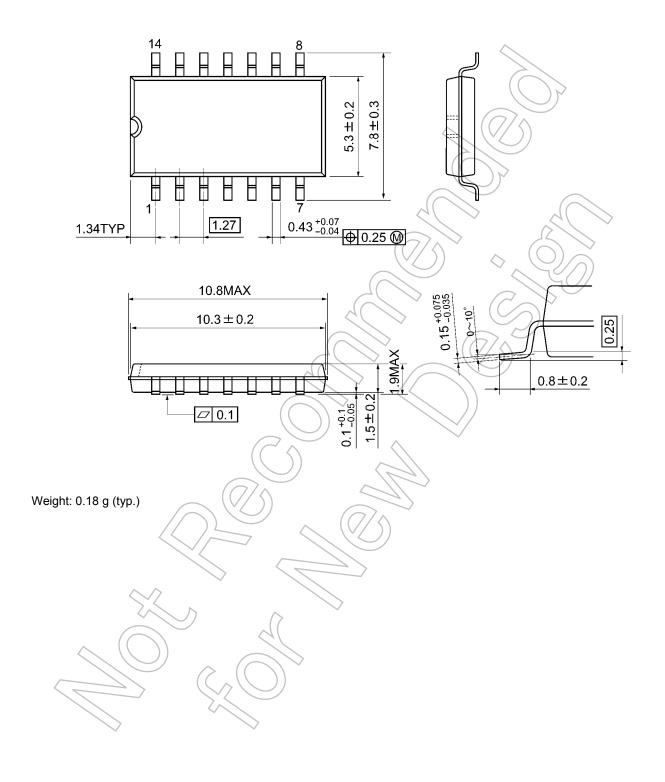
DIP14-P-300-2.54 Unit: mm





### **Package Dimensions**

SOP14-P-300-1.27A Unit: mm



6

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